

Re: Issue of Hitachi Capital Corporation's 69th, and 70th Unsecured Straight Bonds
(with Limited Interbond Pari Passu Clause)

Hitachi Capital Corporation wishes to announce that it has determined the following terms and conditions for the issuance of its 69th, and 70th unsecured straight bonds.

- Description -

		69th	70th
1.	Total issue amount	¥ 30 billion	¥ 15 billion
2.	Denomination per bond	¥ 100 million	
3.	Interest rate	0.080% per annum	0.200% per annum
4.	Payment amount	¥100 per ¥100 bond face value	
5.	Redemption price	¥100 per ¥100 bond face value	
6.	Redemption date	The principal of the bond will be redeemed in full on December 18, 2020	The principal of the bond will be redeemed in full on December 20, 2022
7.	Interest payment dates	June 20 and December 20 of each year	
8.	Offering period	November 30, 2017	
9.	Payment date	December 6, 2017	
10.	Offering method	Offering to the general public	
11.	Collateral	No collateral or guarantee is pledged and no assets are specifically reserved to secure these bonds	
12.	Financial covenants	Negative pledge clause (with limited interbond pari passu clause)	
13.	Underwriters	Nomura Securities Co.,Ltd. SMBC Nikko Securities Inc. Tokai Tokyo Securities Co., Ltd. Mitsubishi UFJ Morgan Stanley Securities Co., Ltd. Okasan Securities Co., Ltd.	Mitsubishi UFJ Morgan Stanley Securities Co., Ltd. Nomura Securities Co.,Ltd. SMBC Nikko Securities Inc. Tokai Tokyo Securities Co., Ltd.
14.	Place for handling subscriptions	Head office and domestic branches of underwriters	
15.	Financial agent	Mizuho Bank, Ltd.	
16.	Book-entry transfer institution	Japan Securities Depository Center, Incorporated	
17.	Ratings (to be obtained)	A+ (Rating and Investment Information, Inc.) AA- (Japan Credit Rating Agency, Ltd.)	